

PLEASE CHECK WWW.MOLEX.COM FOR LATEST PART INFORMATION

Part Number: [73771-0100](#)
Status: **Active**
Overview: [HDM® Backplane Connector System](#)
Description: HDM® Board-to-Board Stacking Header, High Rise Vertical, SMC, Press-Fit, Guide Pin Option, Keying Option A, 72 Circuits

Documents:
[3D Model](#)
[Drawing \(PDF\)](#)
[Product Specification PS-73780-999 \(PDF\)](#)
[RoHS Certificate of Compliance \(PDF\)](#)

Agency Certification

CSA LR19980
UL E29179

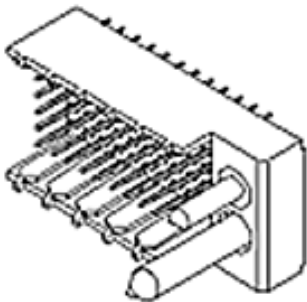
General

Product Family Backplane Connectors
Series [73771](#)
Application Midplane
Component Type PCB Header
Overview [HDM® Backplane Connector System](#)
Product Name HDM®
Style N/A
UPC 800754007559

Physical

Circuits (Loaded) 72
Circuits (maximum) 72
Color - Resin Black
Durability (mating cycles max) 250
Flammability 94V-0
Guide to Mating Part Yes
Keying to Mating Part Yes
Material - Metal Phosphor Bronze, Stainless Steel
Material - Plating Mating Gold
Material - Plating Termination Tin-Lead
Material - Resin High Temperature Thermoplastic
Net Weight 15.470/g
Number of Columns 12
Number of Pairs Open Pin Field
Number of Rows 6
Orientation Vertical
PC Tail Length 3.50mm
PCB Locator No
PCB Retention Yes
PCB Thickness - Recommended 2.50mm
Packaging Type Tube
Pitch - Mating Interface 2.00mm
Plating min - Mating 0.762µm
Plating min - Termination 0.381µm
Polarized to PCB No
Stackable Yes
Surface Mount Compatible (SMC) Yes
Temperature Range - Operating -55°C to +105°C
Termination Interface: Style Through Hole - Compliant Pin

Electrical



Series

image - Reference only

EU RoHS
ELV and RoHS
Compliant
REACH SVHC
Contains SVHC: No
Low-Halogen Status
Low-Halogen

China RoHS



Need more information on product environmental compliance?

Email productcompliance@molex.com
For a multiple part number RoHS Certificate of Compliance, [click here](#)

Please visit the [Contact Us](#) section for any non-product compliance questions.

Search Parts in this Series
[73771Series](#)

Mates With
73632 HDM PLUS® Board-to-Board Daughterboard Receptacle, 73780 HDM® Board-to-Board Daughtercard Receptacle

Application Tooling | FAQ
Tooling specifications and manuals are found by selecting the products below. Crimp Height Specifications are then contained in the Application Tooling Specification document.
Global

Description	Product #
Backplane Insertion	0621001400
Signal Contact Tool	
Extraction Tool	0621001000

Current - Maximum per Contact	1A
Data Rate	1.0 Gbps
Voltage - Maximum	250V AC

Material Info

Reference - Drawing Numbers

Product Specification	PS-73780-999
Sales Drawing	SD-73771-001

HDM and High Density Metric are trademarks of Amphenol Corporation

This document was generated on 10/01/2014

PLEASE CHECK WWW.MOLEX.COM FOR LATEST PART INFORMATION